_ AS	PC SSOCIATION CONNECTING ECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc Iternational and Pan-Americ	kburn, Illinois	. All rights reserv	tion with lower	level p	oarts, the o	declaratio	n encompa		er level mate	erials for	which th	item is an assembly e manufacturer has eclaration.	
17	52-2 1.1		Neb Site for Informat	-1752 Standa					laration Class * ss 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat							
Sup	plier Information															
Cor	npany Name *	Company Unique ID			Unique ID Authority			Response Date *			Response Document ID					
SEN	ITECH CORPORATIO	о п	SEMTECH CORPOR	RATION				05-24								
Contact Name *			Title - Contact		Phone - Contact *			- Contact	t *			0 1 1	A (1			
ROYA READER			Quality Assurance C	ustomer S	805-389-274	rreader@semtech.com				Duplicate	Contact	-> Autho	rized Re	presentative		
Aut	Authorized Representati		* Title - Representative		Phone - Representative *		Email - Representative *			* Su	Supplier Comments or URL for Additional Information					
ROYA READER			Quality Assurance C	ustomer S	805-389-274	rreader@semtech.com										
Requester Item Number		r (Mfr Item Number		Mfr Item Name	Effective Date Version			Manufacturing Site		Weight *	UC	M	Unit Type		
			RClamp7522T.TCT	Ultra Low Ca		apacitance TVS Arra		a		China		0.821	mg	I	Each	
	Alternate Recommenda	Alternate Recommendation				Alternate Item			Item Comr	Comments						
Ма	nufacturing Proces	ss Inf	formation													
Terminal Plating / Grid Array Mate		Materi	rial Terminal B		Base Alloy J-STD-020 MSL R		ating Peak Process Bo		ess Body	Temperatu	ature Max Time at Peak Tempera		perature	Ire Number of Reflow Cycles		
Nickel/Palladium/Gold (Ni/Pd/Au) CU Allo Comments			CU Alloy	,	1				2 60 C	30 seconds		3				
RC	lamp7522T.TCT is RI	EACH	-compliant product	, per EU R	egulation EC	C1907/2006 to inc	lude re	ecent add	ition of S	SVHC car	ndidate list o	f substanc	es in Fe	bruary 2	2012.	

Save the fields in this form to a file	Evport Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cupplier Fields
RoHS Materia	Composition Declar	ation				Declaration Type	* Detailed
		ty limit of 0.1% by mass (100 Ethers (PBDE) and quantity					ominated Biphenyls (PBB),
chromium, polybromina excess of an applicable gathered the information Company will rely on thi completing this form, ar certifications regarding conditions of that agree	ted biphenyls and/or polybrominate quantity limit, please indicate below it provides in this form using app s certification in determining the co d that Supplier may not have inde heir contributions to the part, and ment, including any warranty rights	ompliance of its products with European pendently verified such information. Ho those certifications are at least as comp	ricted substance?) in excess believe may apply. If the p y and that such information n Union member state laws owever, in situations where prehensive as the certificati hat agreement, will be the s	ss of the applicable quantity lim part is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independently ion in this paragraph. If the Co sole and exclusive source of the	it identified above. If a homoge evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges y verified information provided lo popany and the Supplier enter is a Supplier?s liability and the Co	eneous material within the part cor on shall encompass all such comp of the date that Supplier complete: s that Supplier may have relied on by others, Supplier agrees that, at into a written agreement with resp impany?s remedies for issues that	ntains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that information provided by others in a minimum, its suppliers have provided
RoHS Declaration	n * 1 - Item(s) does not conta	ain RoHS restricted substances per the	he definition above			Supplier Acceptance *	Accepted
	e declared item does not co all applicable exemptions.	ntain RoHS restricted substanc	es per the definition a	above except for defined	RoHS exemptions, then	select the corresponding re	esponse in the RoHS Declaration
Declaration S	ignature						
In a family of the second	ward a factor and the factor of the second s	al Calaba and all manages of the last		a second se		and the second s	town - town

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight		Tolerance		PPM
	Name		Material	weight	Measure			Level	Substance Category			Substance	CAS	Exempt	weight	Measure	-	+	
+I -I	Die	+M -M	Doped Silicon	0.0288	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		0.0288	mg			35,100
+I -I	Lead frame	+M -M	C7025	0.309582	2mg	+C	-C	Supplier		+S	-S	Cu	7440-50-8		0.2969	mg			361,83
	•									+S	-s	Si	7440-21-3		0.0022	mg			2,735
						+C	-C	В	Nickel (external applic	+S	-s	Nickel	7440-02-0		0.0099	mg			12,074
						+C	-C	Supplier		+S	-s	Mg	7439-95-4		0.0005	mg			660
		+M -M	Ni/Pd/Au plating	0.007938	mg	+C	-C	в		+S	-s	Nickel	7440-02-0		0.0072	mg			8,723
						+C	-C	Supplier	middle plating	+S	-s	Pd	7440-05-3		0.0007	mg			793
						+C	-C	Supplier	outer plating	+S	-s	Au	7440-57-5		0.0001	mg			158
+ -	Bonding wire	+M -M	Gold wire	0.0113	mg	+C	-C	Supplier		+S	-s	Au	7440-57-5		0.0113	mg			13,737
+ -	Molding compound	+M -M	EME-G770HCD	0.456399	mg	+C	-C	Supplier		+S	-s	Silica fused	60676-86-0		0.4267	mg			520,07
	•									+S	-s	Epoxy resin	Proprietary		0.0137	mg			16,687
										+S	-s	Phenol resin	Proprietary		0.0137	mg			16,687
										+S	-s	Carbon Black	1333-86-4		0.0023	mg			2,781
+ -	Die attached epoxy	+M -M	8006NS	0.00653 [,]	Img	+C	-C	Supplier		+S	-s	Treated silica	Proprietary		0.0005	mg			637
	•									+S	-s	Glycol ethers	Proprietary		0.0013	mg			1,592
										+S	-s	Metal oxide	Proprietary		0.0018	mg			2,229
										+S	-s	Curing agent & hardene	Proprietary		0.0005	mg			637
										+S	-s	epoxy resins	Proprietary		0.0024	mg			2,865